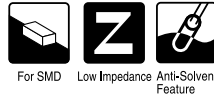
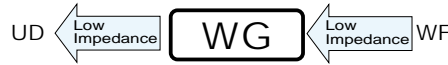
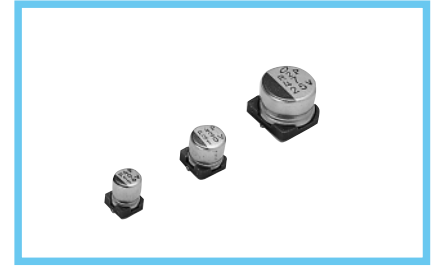


WG series Chip Type, Low Impedance



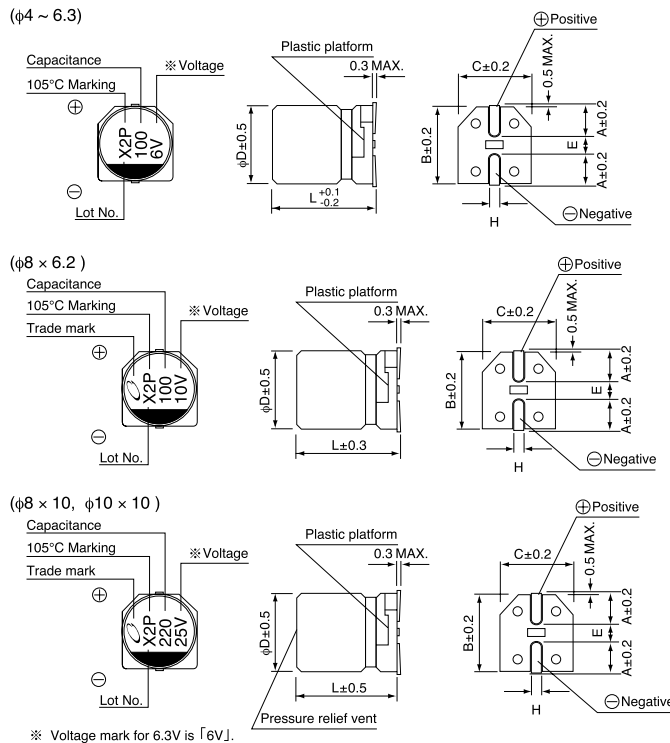
- Chip type, operating over wide temperature range of to $-55 \sim +105^{\circ}\text{C}$.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).



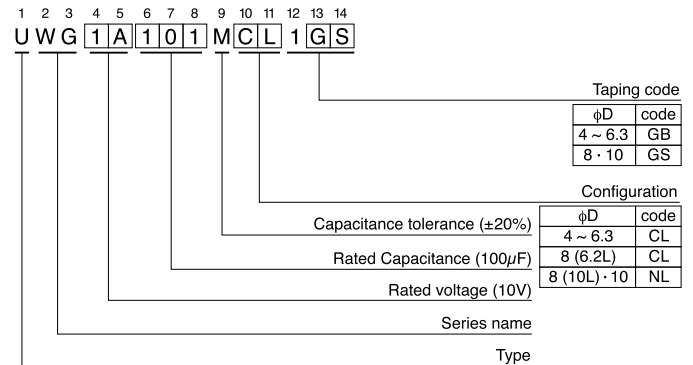
Specifications

Item	Performance Characteristics							
Category Temperature Range	$-55 \sim +105^{\circ}\text{C}$							
Rated Voltage Range	6.3 ~ 50V							
Rated Capacitance Range	1 ~ 1500 μF							
Capacitance Tolerance	$\pm 20\%$ at 120Hz, 20°C							
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01CV or 3 (μA), whichever is greater.							
tan δ	Measurement frequency : 120Hz, Temperature : 20°C							
	Rated voltage (V)	6.3	10	16	25	35	50	
Stability at Low Temperature	Measurement frequency : 120Hz							
	Rated voltage (V)		6.3	10	16	25	35	50
	Impedance ratio	Z-25°C / Z+20°C	2	2	2	2	2	2
Endurance	ZT / Z20 (MAX.)		Z-55°C / Z+20°C	4	4	3	3	3
	After 1000 hours' application of rated voltage at 105°C, capacitors meet the characteristic requirements listed at right.		Capacitance change	Within $\pm 20\%$ of initial value				
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.		tan δ	200% or less of initial specified value				
	Resistance to soldering heat		Leakage current	Initial specified value or less				
Marking	The capacitors shall be kept on the hot plate maintained at 250°C for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right.		Capacitance change	Within $\pm 10\%$ of initial value				
	Black print on the case top.		tan δ	Initial specified value or less				
			Leakage current	Initial specified value or less				

Chip Type



Type numbering system (Example : 10V 100 μF)



$\phi\text{D} \times \text{L}$	(mm)					
	4 × 5.4	5 × 5.4	6.3 × 5.4	8 × 6.2	8 × 10	10 × 10
A	1.8	2.1	2.4	3.3	2.9	3.2
B	4.3	5.3	6.6	8.3	8.3	10.3
C	4.3	5.3	6.6	8.3	8.3	10.3
E	1.0	1.3	2.2	2.3	3.1	4.5
L	5.4	5.4	5.4	6.2	10	10
H	0.5 ~ 0.8	0.5 ~ 0.8	0.5 ~ 0.8	0.5 ~ 0.8	0.8 ~ 1.1	0.8 ~ 1.1

● Dimension table in next page.

■ Dimensions

Cap. (μ F)	V Code	6.3			10			16		
		0J			1A			1C		
10	100							4×5.4	3.0	60
22	220	4×5.4	3.0	60				5×5.4	1.8	95
33	330				5×5.4	1.8	95			
47	470	5×5.4	1.8	95				6.3×5.4	1.0	140
68	680	6.3×5.4	1.0	140				8×6.2	0.4	230
100	101	6.3×5.4	1.0	140	8×6.2	0.4	230	8×6.2	0.4	230
150	151				8×6.2	0.4	230			
220	221	8×6.2	0.4	230	8×10	0.3	450	10×10	0.15	670
330	331	8×10	0.3	450				10×10	0.15	670
470	471				10×10	0.15	670	10×10	0.15	670
680	681							10×10	0.15	670
1000	102	10×10	0.15	670	10×10	0.15	670			
1500	152	10×10	0.15	670						

Cap. (μ F)	V Code	25			35			50		
		1E			1V			1H		
1	010				4×5.4	3.0	60	4×5.4	5.0	30
2.2	2R2				4×5.4	3.0	60	4×5.4	5.0	30
3.3	3R3				4×5.4	3.0	60	4×5.4	5.0	30
4.7	4R7				4×5.4	3.0	60	5×5.4	3.0	50
6.8	6R8	4×5.4	3.0	60	5×5.4	1.8	95			
10	100				5×5.4	1.8	95	6.3×5.4	2.0	70
22	220	6.3×5.4	1.0	140	6.3×5.4	1.0	140	8×6.2	0.7	120
33	330	6.3×5.4	1.0	140	8×6.2	0.4	230	8×10	0.6	300
47	470	8×6.2	0.4	230	8×6.2	0.4	230	10×10	0.3	500
68	680	8×10	0.3	450						
100	101	8×10	0.3	450	10×10	0.15	670	10×10	0.3	500
220	221	10×10	0.15	670	10×10	0.15	670	10×10	0.3	500
330	331	10×10	0.15	670	10×10	0.15	670			
470	471	10×10	0.15	670				Case size ϕ D×L (mm)	Impedance	Rated ripple

Max. Impedance (Ω) at 20°C 100kHz
 Rated Ripple (mArms) at 105°C 100kHz

● Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz~
Coefficient	0.35	0.50	0.64	0.83	1.00

- Taping specifications are given in page 24.
- Recommended land size, soldering by reflow are given in page 25, 26.
- Please select UJ(p.76) series if high C/V products are required.
- Please refer to page 3 for the minimum order quantity.